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### What is "[Embedded - Microcontrollers](#)"?

"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

### Applications of "[Embedded - Microcontrollers](#)"

#### Details

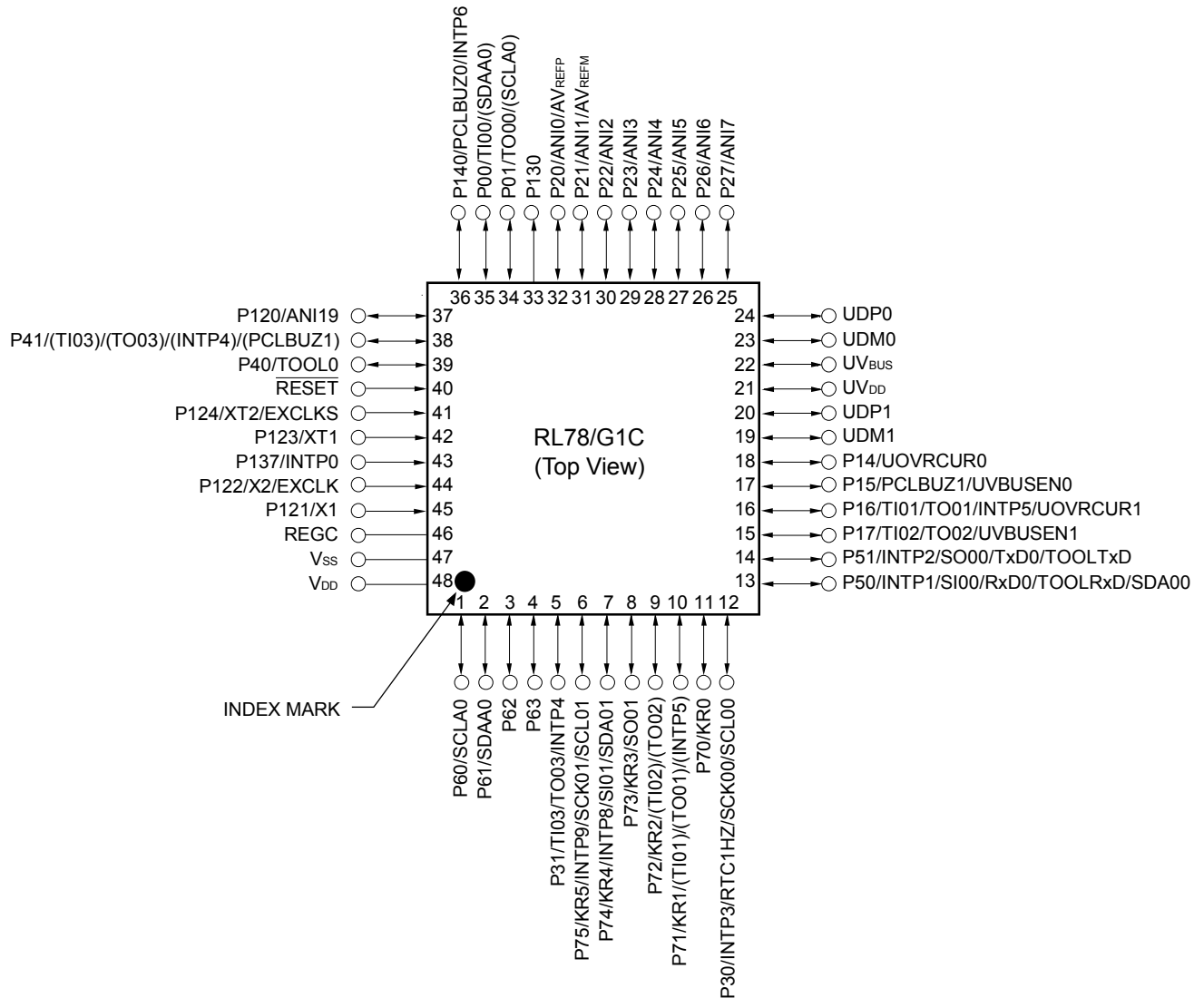
Product Status	Obsolete
Core Processor	RL78
Core Size	16-Bit
Speed	24MHz
Connectivity	CSI, I <sup>2</sup> C, UART/USART, USB
Peripherals	DMA, LVD, POR, PWM, WDT
Number of I/O	22
Program Memory Size	32KB (32K x 8)
Program Memory Type	FLASH
EEPROM Size	2K x 8
RAM Size	5.5K x 8
Voltage - Supply (Vcc/Vdd)	2.4V ~ 5.5V
Data Converters	A/D 8x8/10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	32-WFQFN Exposed Pad
Supplier Device Package	32-HWQFN (5x5)
Purchase URL	<a href="https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f10kbcana-u0">https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f10kbcana-u0</a>

## 1.3.2 48-pin products

- 48-pin plastic LFQFP (fine pitch) (7 × 7, 0.5 mm pitch)

## (1) USB function: Host/Function controller (R5F10JGC)

&lt;R&gt;



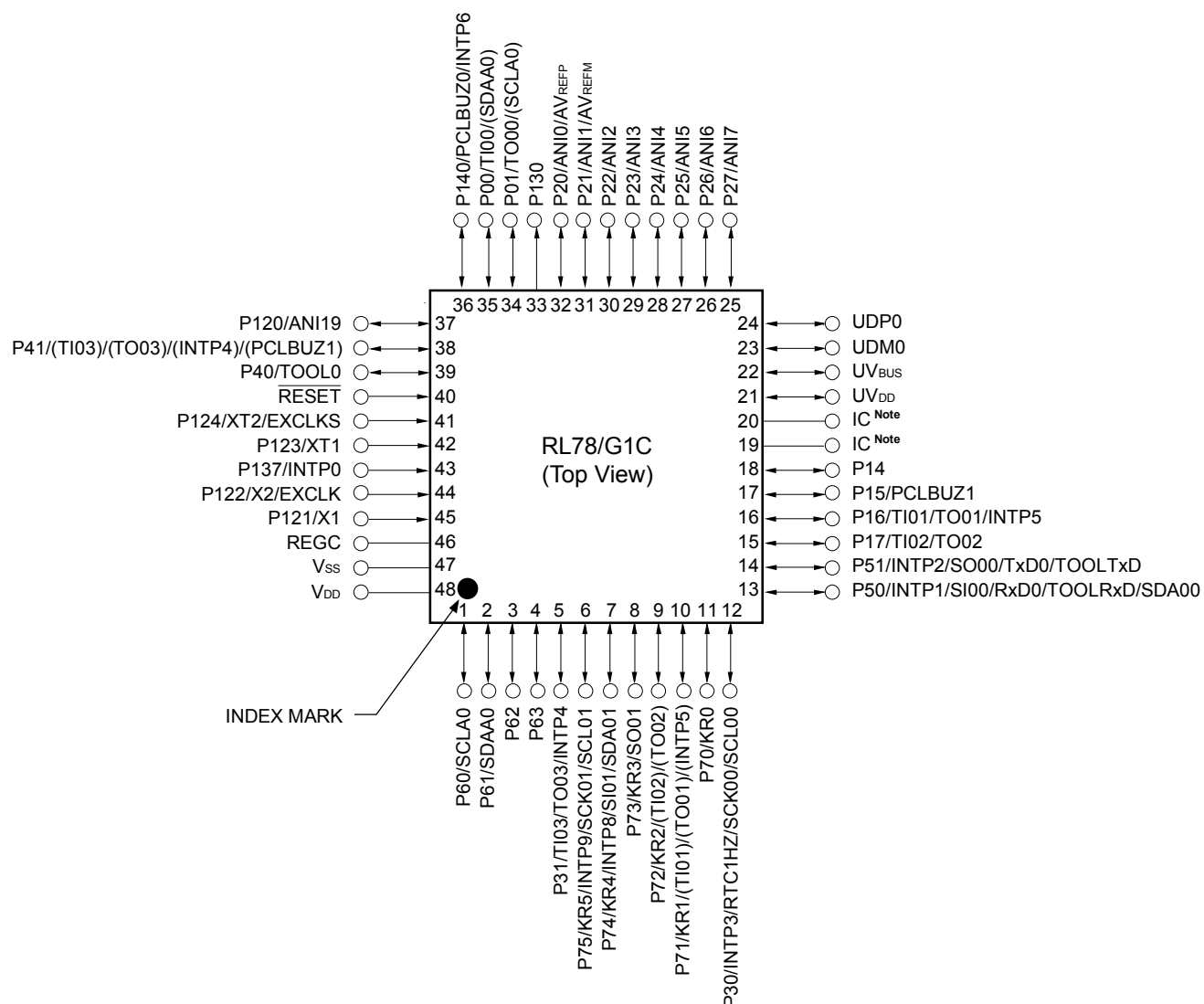
**Caution** Connect the REGC pin to V<sub>SS</sub> via a capacitor (0.47 to 1  $\mu$ F).

**Remarks 1.** For pin identification, see 1.4 Pin Identification.

- 2.** Functions in parentheses in the above figure can be assigned via settings in the peripheral I/O redirection register (PIOR).

## (2) USB function: Function controller only (R5F10KGC)

&lt;R&gt;



**Note** IC: Internal Connection Pin Leave open.

**Caution** Connect the REGC pin to V<sub>SS</sub> via a capacitor (0.47 to 1  $\mu$ F).

**Remarks 1.** For pin identification, see 1.4 Pin Identification.

**2.** Functions in parentheses in the above figure can be assigned via settings in the peripheral I/O redirection register (PIOR).

## 1.6 Outline of Functions

[32-pin, 48-pin products]

(1/2)

Item		32-pin		48-pin		
		R5F10JBC	R5F10KBC	R5F10JGC	R5F10KGC	
Code flash memory (KB)		32 KB		32 KB		
Data flash memory (KB)		2 KB		2 KB		
RAM (KB)		5.5 KB <sup>Note 1</sup>		5.5 KB <sup>Note 1</sup>		
Memory space		1 MB				
<R>	Main system clock	High-speed system clock	X1 (crystal/ceramic) oscillation, external main system clock input (EXCLK) HS (High-speed main) mode: 1 to 20 MHz (V <sub>DD</sub> = 2.7 to 5.5 V), HS (High-speed main) mode: 1 to 16 MHz (V <sub>DD</sub> = 2.4 to 5.5 V)			
		High-speed on-chip oscillator	1 to 24 MHz (V <sub>DD</sub> = 2.7 to 5.5 V), 1 to 16 MHz (V <sub>DD</sub> = 2.4 to 5.5 V)			
		PLL clock	6, 12, 24 MHz <sup>Note 2</sup> : V <sub>DD</sub> = 2.4 to 5.5 V			
Subsystem clock		-		XT1 (crystal) oscillation 32.768 kHz (TYP.): V <sub>DD</sub> = 2.4 to 5.5 V		
Low-speed on-chip oscillator		On-chip oscillation (Watchdog timer/Real-time clock/12-bit interval timer clock) 15 kHz (TYP.): V <sub>DD</sub> = 2.4 to 5.5 V				
General-purpose register		8 bits × 32 registers (8 bits × 8 registers × 4 banks)				
Minimum instruction execution time		0.04167 μs (High-speed on-chip oscillator: f <sub>HOCO</sub> = 48 MHz /f <sub>IH</sub> = 24 MHz operation)				
		0.04167 μs (PLL clock: f <sub>PLL</sub> = 48 MHz /f <sub>IH</sub> = 24 MHz <sup>Note 2</sup> operation)				
		0.05 μs (High-speed system clock: f <sub>MX</sub> = 20 MHz operation)				
		-		30.5 μs (Subsystem clock: f <sub>SUB</sub> = 32.768 kHz operation)		
Instruction set		<ul style="list-style-type: none"> <li>• Data transfer (8/16 bits)</li> <li>• Adder and subtractor/logical operation (8/16 bits)</li> <li>• Multiplication (8 bits × 8 bits)</li> <li>• Rotate, barrel shift, and bit manipulation (Set, reset, test, and Boolean operation), etc.</li> </ul>				
I/O port	Total	22		38		
	CMOS I/O	16 (N-ch O.D. I/O [V <sub>DD</sub> withstand voltage]: 5)		28 (N-ch O.D. I/O [V <sub>DD</sub> withstand voltage]: 6)		
	CMOS input	3		5		
	CMOS output	-		1		
	N-ch open-drain I/O (6 V tolerance)	3		4		
Timer	16-bit timer	4 channel				
	Watchdog timer	1 channel				
	Real-time clock (RTC)	1 channel <sup>Note 3</sup>				
	12-bit Interval timer (IT)	1 channel				
	Timer output	4 channels (PWM output: 3) <sup>Note 4</sup>				
	RTC output	-		1 • 1 Hz (subsystem clock: f <sub>SUB</sub> = 32.768 kHz)		

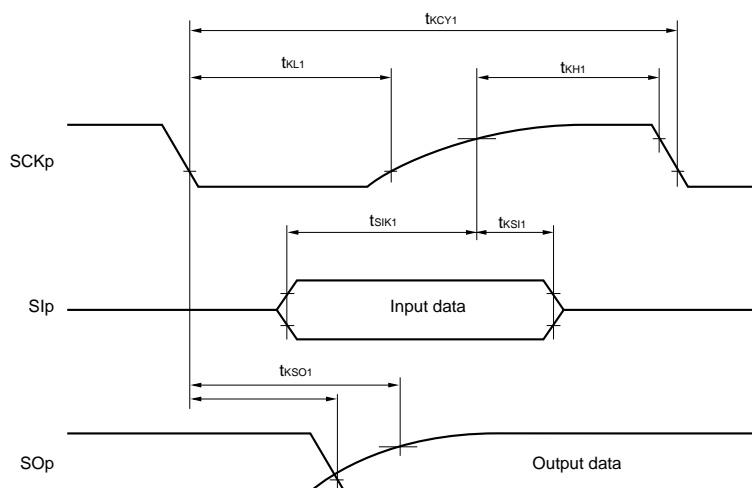
- Notes**
1. In the case of the 5.5 KB, this is about 4.5 KB when the self-programming function is used.
  2. In the PLL clock 48 MHz operation, the system clock is 2/4/8 dividing ratio.
  3. In 32-pin products, this channel can only be used for the constant-period interrupt function based on the low-speed on-chip oscillator clock ( $f_{IL}$ ).
  4. The number of PWM outputs varies depending on the setting of channels in use (the number of masters and slaves).

**Caution** This outline describes the functions at the time when Peripheral I/O redirection register (PIOR) is set to 00H.

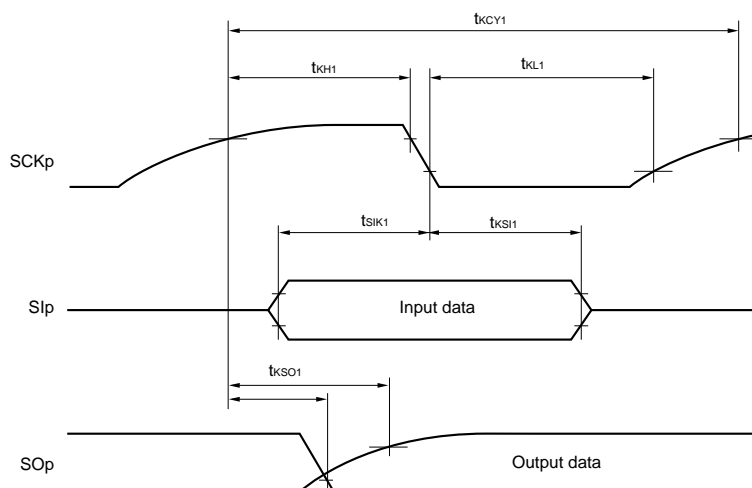
- Notes**
1. Current flowing to  $V_{DD}$ .
  2. When high speed on-chip oscillator and high-speed system clock are stopped.
  3. Current flowing only to the real-time clock (RTC) (excluding the operating current of the low-speed on-chip oscillator and the XT1 oscillator). The supply current of the RL78 microcontrollers is the sum of the values of either  $I_{DD1}$  or  $I_{DD2}$ , and  $I_{RTC}$ , when the real-time clock operates in operation mode or HALT mode. When the low-speed on-chip oscillator is selected,  $I_{FIL}$  should be added.  $I_{DD2}$  subsystem clock operation includes the operational current of the real-time clock.
  4. Current flowing only to the 12-bit interval timer (excluding the operating current of the low-speed on-chip oscillator and the XT1 oscillator). The supply current of the RL78 microcontrollers is the sum of the values of either  $I_{DD1}$  or  $I_{DD2}$ , and  $I_{IT}$ , when the 12-bit interval timer operates in operation mode or HALT mode. When the low-speed on-chip oscillator is selected,  $I_{FIL}$  should be added.
  5. Current flowing only to the watchdog timer (including the operating current of the low-speed on-chip oscillator). The supply current of the RL78 microcontrollers is the sum of  $I_{DD1}$ ,  $I_{DD2}$  or  $I_{DD3}$  and  $I_{WDT}$  when the watchdog timer is in operation.
  6. Current flowing only to the A/D converter. The supply current of the RL78 microcontrollers is the sum of  $I_{DD1}$  or  $I_{DD2}$  and  $I_{ADC}$  when the A/D converter operates in an operation mode or the HALT mode.
  7. Current flowing only to the LVD circuit. The current value of the RL78/G1C is the sum of  $I_{DD1}$ ,  $I_{DD2}$  or  $I_{DD3}$  and  $I_{LVI}$  when the LVD circuit operates in the Operating, HALT or STOP mode.
  8. Current flowing only during data flash rewrite.
  9. Current flowing only during self programming.
  10. For shift time to the SNOOZE mode.
  11. Current consumed only by the USB module and the internal power supply for the USB.
  12. Includes the current supplied from the pull-up resistor of the UDP0 pin to the pull-down resistor of the host device, in addition to the current consumed by this MCU during the suspended state.

- Remarks**
1.  $f_{IL}$ : Low-speed on-chip oscillator clock frequency
  2.  $f_{SUB}$ : Subsystem clock frequency (XT1 clock oscillation frequency)
  3.  $f_{CLK}$ : CPU/peripheral hardware clock frequency
  4. Temperature condition of the TYP. value is  $T_A = 25^{\circ}\text{C}$

**CSI mode serial transfer timing (master mode) (during communication at different potential)**  
**(When DAPmn = 0 and CKPmn = 0, or DAPmn = 1 and CKPmn = 1.)**



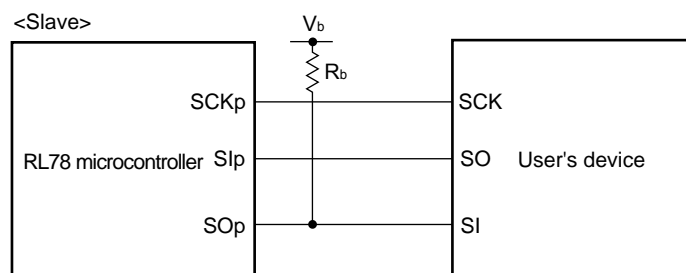
**CSI mode serial transfer timing (master mode) (during communication at different potential)**  
**(When DAPmn = 0 and CKPmn = 1, or DAPmn = 1 and CKPmn = 0.)**



- Remarks**
1. p: CSI number (p = 00), m: Unit number, n: Channel number (mn = 00), g: PIM and POM number (g = 0, 3, 5, 7)
  2. CSI01 cannot communicate at different potential. Use other CSI for communication at different potential.

**Caution** Select the TTL input buffer for the SIp pin and the N-ch open drain output ( $V_{DD}$  tolerance) mode for the SOp pin and SCKp pin by using port input mode register g (PIMg) and port output mode register g (POMg). For  $V_{IH}$  and  $V_{IL}$ , see the DC characteristics with TTL input buffer selected.

**CSI mode connection diagram (during communication at different potential)**



- Remarks**
1.  $R_b[\Omega]$ : Communication line (SO<sub>p</sub>) pull-up resistance,  $C_b[F]$ : Communication line (SO<sub>p</sub>) load capacitance,  $V_b[V]$ : Communication line voltage
  2. p: CSI number (p = 00), m: Unit number, n: Channel number (mn = 00), g: PIM and POM number (g = 0, 3, 5, 7)
  3.  $f_{MCK}$ : Serial array unit operation clock frequency  
(Operation clock to be set by the CKSmn bit of serial mode register mn (SMRmn).  
m: Unit number, n: Channel number (mn = 00))
  4. CSI01 cannot communicate at different potential. Use other CSI for communication at different potential.

## 2.5.2 Serial interface IICA

(1) I<sup>2</sup>C standard mode(T<sub>A</sub> = -40 to +85°C, 2.4 V ≤ V<sub>DD</sub> ≤ 5.5 V, V<sub>SS</sub> = 0 V)

Parameter	Symbol	Conditions		HS (high-speed main) mode		Unit
				MIN.	MAX.	
SCLA0 clock frequency	f <sub>SCL</sub>	Standard mode: f <sub>CLK</sub> ≥ 1 MHz	2.7 V ≤ V <sub>DD</sub> ≤ 5.5 V	0	100	kHz
			2.4 V ≤ V <sub>DD</sub> ≤ 5.5 V	0	100	kHz
Setup time of restart condition	t <sub>SU:STA</sub>	2.7 V ≤ V <sub>DD</sub> ≤ 5.5 V		4.7		μs
		2.4 V ≤ V <sub>DD</sub> ≤ 5.5 V		4.7		μs
Hold time <sup>Note 1</sup>	t <sub>HD:STA</sub>	2.7 V ≤ V <sub>DD</sub> ≤ 5.5 V		4.0		μs
		2.4 V ≤ V <sub>DD</sub> ≤ 5.5 V		4.0		μs
Hold time when SCLA0 = "L"	t <sub>LOW</sub>	2.7 V ≤ V <sub>DD</sub> ≤ 5.5 V		4.7		μs
		2.4 V ≤ V <sub>DD</sub> ≤ 5.5 V		4.7		μs
Hold time when SCLA0 = "H"	t <sub>HIGH</sub>	2.7 V ≤ V <sub>DD</sub> ≤ 5.5 V		4.0		μs
		2.4 V ≤ V <sub>DD</sub> ≤ 5.5 V		4.0		μs
Data setup time (reception)	t <sub>SU:DAT</sub>	2.7 V ≤ V <sub>DD</sub> ≤ 5.5 V		250		μs
		2.4 V ≤ V <sub>DD</sub> ≤ 5.5 V		250		μs
Data hold time (transmission) <sup>Note 2</sup>	t <sub>HD:DAT</sub>	2.7 V ≤ V <sub>DD</sub> ≤ 5.5 V		0	3.45	μs
		2.4 V ≤ V <sub>DD</sub> ≤ 5.5 V		0	3.45	μs
Setup time of stop condition	t <sub>SU:STO</sub>	2.7 V ≤ V <sub>DD</sub> ≤ 5.5 V		4.0		μs
		2.4 V ≤ V <sub>DD</sub> ≤ 5.5 V		4.0		μs
Bus-free time	t <sub>BUF</sub>	2.7 V ≤ V <sub>DD</sub> ≤ 5.5 V		4.7		μs
		2.4 V ≤ V <sub>DD</sub> ≤ 5.5 V		4.7		μs

**Notes** 1. The first clock pulse is generated after this period when the start/restart condition is detected.2. The maximum value (MAX.) of t<sub>HD:DAT</sub> is during normal transfer and a wait state is inserted in the  $\overline{\text{ACK}}$  (acknowledge) timing.

**Caution** The values in the above table are applied even when bit 1 (PIOR1) in the peripheral I/O redirection register (PIOR) is 1. At this time, the pin characteristics (I<sub>OH1</sub>, I<sub>OL1</sub>, V<sub>OH1</sub>, V<sub>OL1</sub>) must satisfy the values in the redirect destination.

**Remark** The maximum value of C<sub>b</sub> (communication line capacitance) and the value of R<sub>b</sub> (communication line pull-up resistor) at that time in each mode are as follows.

Standard mode: C<sub>b</sub> = 400 pF, R<sub>b</sub> = 2.7 kΩ



(3) I<sup>2</sup>C fast mode plus(T<sub>A</sub> = -40 to +85°C, 2.4 V ≤ V<sub>DD</sub> ≤ 5.5 V, V<sub>SS</sub> = 0 V)

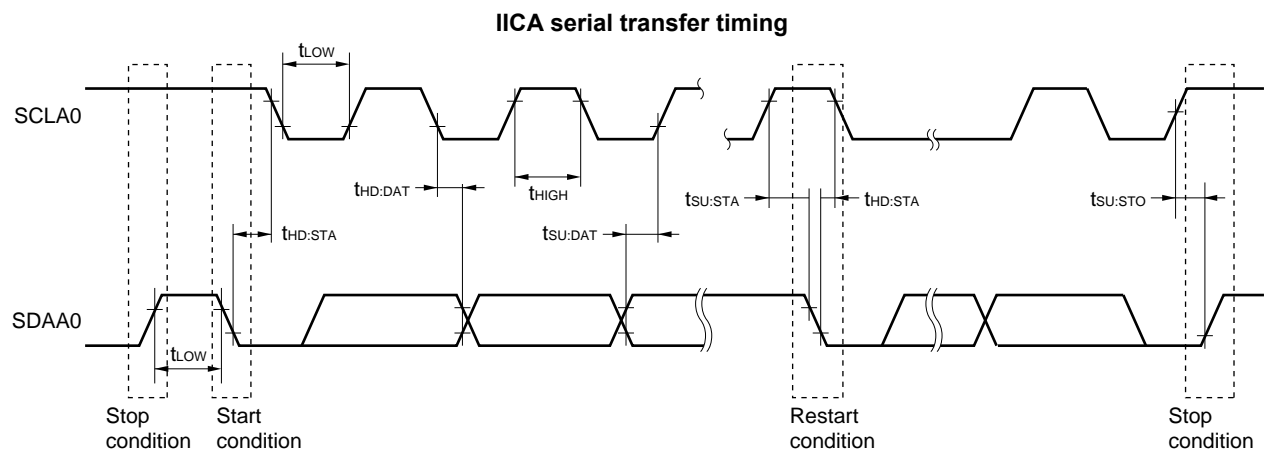
Parameter	Symbol	Conditions		HS (high-speed main) Mode		Unit
				MIN.	MAX.	
SCLA0 clock frequency	f <sub>SCL</sub>	Fast mode plus: f <sub>CLK</sub> ≥ 10 MHz	2.7 V ≤ V <sub>DD</sub> ≤ 5.5 V	0	1000	kHz
Setup time of restart condition	t <sub>SU:STA</sub>	2.7 V ≤ V <sub>DD</sub> ≤ 5.5 V		0.26		μs
Hold time <sup>Note 1</sup>	t <sub>HD:STA</sub>	2.7 V ≤ V <sub>DD</sub> ≤ 5.5 V		0.26		μs
Hold time when SCLA0 = "L"	t <sub>LOW</sub>	2.7 V ≤ V <sub>DD</sub> ≤ 5.5 V		0.5		μs
Hold time when SCLA0 = "H"	t <sub>HIGH</sub>	2.7 V ≤ V <sub>DD</sub> ≤ 5.5 V		0.26		μs
Data setup time (reception)	t <sub>SU:DAT</sub>	2.7 V ≤ V <sub>DD</sub> ≤ 5.5 V		50		ns
Data hold time (transmission) <sup>Note 2</sup>	t <sub>HD:DAT</sub>	2.7 V ≤ V <sub>DD</sub> ≤ 5.5 V		0	0.45	μs
Setup time of stop condition	t <sub>SU:STO</sub>	2.7 V ≤ V <sub>DD</sub> ≤ 5.5 V		0.26		μs
Bus-free time	t <sub>BUF</sub>	2.7 V ≤ V <sub>DD</sub> ≤ 5.5 V		0.5		μs

- Notes**
1. The first clock pulse is generated after this period when the start/restart condition is detected.
  2. The maximum value (MAX.) of t<sub>HD:DAT</sub> is during normal transfer and a wait state is inserted in the ACK (acknowledge) timing.

**Caution** The values in the above table are applied even when bit 1 (PIOR1) in the peripheral I/O redirection register (PIOR) is 1. At this time, the pin characteristics (I<sub>OH1</sub>, I<sub>OL1</sub>, V<sub>OH1</sub>, V<sub>OL1</sub>) must satisfy the values in the redirect destination.

**Remark** The maximum value of C<sub>b</sub> (communication line capacitance) and the value of R<sub>b</sub> (communication line pull-up resistor) at that time in each mode are as follows.

Fast mode plus: C<sub>b</sub> = 120 pF, R<sub>b</sub> = 1.1 kΩ



## 2.5.3 USB

## (1) Electrical specifications

(T<sub>A</sub> = -40 to +85°C, 3.0 V ≤ UV<sub>DD</sub> ≤ 3.6 V, 3.0 V ≤ V<sub>DD</sub> ≤ 5.5 V, V<sub>SS</sub> = 0 V)

Parameter		Symbol	Conditions	MIN.	TYP.	MAX.	Unit
UV <sub>DD</sub>	UV <sub>DD</sub> input voltage characteristic	UV <sub>DD</sub>	V <sub>DD</sub> = 3.0 to 5.5 V, PXXCON = 1, VDDUSEB = 0 (UV <sub>DD</sub> ≤ V <sub>DD</sub> )	3.0	3.3	3.6	V
	UV <sub>DD</sub> output voltage characteristic	UV <sub>DD</sub>	V <sub>DD</sub> = 4.0 to 5.5 V, PXXCON = VDDUSEB = 1	3.0	3.3	3.6	V
UV <sub>BUS</sub>	UV <sub>BUS</sub> input voltage characteristic	UV <sub>BUS</sub>	Function	4.35 (4.02 <sup>Note</sup> )	5.00	5.25	V
			Host	4.75	5.00	5.25	V

**Note** Value of instantaneous voltage(T<sub>A</sub> = -40 to +85°C, 3.0 V ≤ UV<sub>DD</sub> ≤ 3.6 V, 3.0 V ≤ V<sub>DD</sub> ≤ 5.5 V, V<sub>SS</sub> = 0 V)

Parameter		Symbol	Conditions	MIN.	TYP.	MAX.	Unit
UDPi/UDMi pins input characteristic (FS/LS receiver)	Input voltage	V <sub>IH</sub>		2.0			V
		V <sub>IL</sub>				0.8	V
	Difference input sensitivity	V <sub>DI</sub>	UDP voltage – UDM voltage	0.2			V
	Difference common mode range	V <sub>CM</sub>		0.8		2.5	V
UDPi/UDMi pins output characteristic (FS driver)	Output voltage	V <sub>OH</sub>	I <sub>OH</sub> = -200 μA	2.8		3.6	V
		V <sub>OL</sub>	I <sub>OL</sub> = 2.4 mA	0		0.3	V
	Transi-ti on time	t <sub>FR</sub>	Rising: From 10% to 90 % of amplitude,	4		20	ns
		t <sub>FF</sub>	Falling: From 90% to 10 % of amplitude,	4		20	ns
	Matching (TFR/TFF)	V <sub>FRFM</sub>	CL = 50 pF	90		111.1	%
	Crossover voltage	V <sub>FCRS</sub>		1.3		2.0	V
	Output Impedance	Z <sub>DRV</sub>	UV <sub>DD</sub> voltage = 3.3 V, Pin voltage = 1.65 V	28		44	Ω
UDPi/UDMi pins output characteristic (LS driver)	Output voltage	V <sub>OH</sub>		2.8		3.6	V
		V <sub>OL</sub>		0		0.3	V
	Transi-ti on time	t <sub>LR</sub>	Rising: From 10% to 90 % of amplitude,	75		300	ns
		t <sub>LF</sub>	Falling: From 90% to 10 % of amplitude,	75		300	ns
	Matching (TFR/TFF) <b>Note</b>	V <sub>LTFM</sub>	CL = 200 to 600 pF	80		125	%
	Crossover voltage <b>Note</b>	V <sub>LCRS</sub>	When the host controller function is selected: The UDMi pin (i = 0, 1) is pulled up via 1.5 kΩ. When the function controller function is selected: The UDP0 and UDM0 pins are individually pulled down via 15 kΩ	1.3		2.0	V
UDPi/UDMi pins pull-up, pull-down	Pull-down resistor	R <sub>PD</sub>		14.25		24.80	kΩ
	Pull-up resistor (i = 0 only)	R <sub>PUI</sub>	Idle	0.9		1.575	kΩ
		R <sub>PUA</sub>	Recep-t ion	1.425		3.09	kΩ
UV <sub>BUS</sub>	UV <sub>BUS</sub> pull-down resistor	R <sub>VBUS</sub>	UV <sub>BUS</sub> voltage = 5.5 V		1000		kΩ
	UV <sub>BUS</sub> input voltage	V <sub>IH</sub>		3.20			V
		V <sub>IL</sub>				0.8	V

**Note** Excludes the first signal transition from the idle state.**Remark** i = 0, 1

### 3. ELECTRICAL SPECIFICATIONS (G: T<sub>A</sub> = -40 to +105°C)

This chapter describes the electrical specifications for the products "G: Industrial applications (T<sub>A</sub> = -40 to +105°C)".

The target products

G: Industrial applications ; T<sub>A</sub> = -40 to +105°C

R5F10JBCGNA, R5F10JBCGFP, R5F10JGCGNA, R5F10JGCGFB,

R5F10KBCGNA, R5F10KBCGFP, R5F10KGCGNA, R5F10KGCGFB

**Cautions** 1. The RL78 microcontrollers has an on-chip debug function, which is provided for development and evaluation. Do not use the on-chip debug function in products designated for mass production, because the guaranteed number of rewritable times of the flash memory may be exceeded when this function is used, and product reliability therefore cannot be guaranteed. Renesas Electronics is not liable for problems occurring when the on-chip debug function is used.

2. The pins mounted depend on the product.

3. Please contact Renesas Electronics sales office for derating of operation under T<sub>A</sub> = +85°C to +105°C. Derating is the systematic reduction of load for the sake of improved reliability.

There are following differences between the products "G: Industrial applications (T<sub>A</sub> = -40 to +105°C)" and the products "A: Consumer applications".

Parameter	Application	
	A: Consumer applications	G: Industrial applications
Operating ambient temperature	T <sub>A</sub> = -40 to +85°C	T <sub>A</sub> = -40 to +105°C
High-speed on-chip oscillator clock accuracy	2.4 V ≤ V <sub>DD</sub> ≤ 5.5 V ±1.0% @ T <sub>A</sub> = -20 to +85°C ±1.5% @ T <sub>A</sub> = -40 to -20°C	2.4 V ≤ V <sub>DD</sub> ≤ 5.5 V ±2.0% @ T <sub>A</sub> = +85 to +105°C ±1.0% @ T <sub>A</sub> = -20 to +85°C ±1.5% @ T <sub>A</sub> = -40 to -20°C
Serial array unit	UART CSI: f <sub>CLK</sub> /2 (supporting 16 Mbps), f <sub>CLK</sub> /4 Simplified I <sup>2</sup> C communication	UART CSI: f <sub>CLK</sub> /4 Simplified I <sup>2</sup> C communication
IICA	Normal mode Fast mode Fast mode plus	Normal mode Fast mode

**Remark** The electrical characteristics of the products G: Industrial applications (T<sub>A</sub> = -40 to +105°C) are different from those of the products "A: Consumer applications". For details, refer to 3.1 to 3.10.

### 3.2 Oscillator Characteristics

#### 3.2.1 X1, XT1 oscillator characteristics

(T<sub>A</sub> = -40 to +105°C, 2.4 V ≤ V<sub>DD</sub> ≤ 5.5 V, V<sub>SS</sub> = 0 V)

Parameter	Resonator	Conditions	MIN.	TYP.	MAX.	Unit
X1 clock oscillation frequency (f <sub>X</sub> ) <sup>Note</sup>	Ceramic resonator/ crystal resonator	2.7 V ≤ V <sub>DD</sub> ≤ 5.5 V	1.0		20.0	MHz
		2.4 V ≤ V <sub>DD</sub> < 2.7 V	1.0		16.0	MHz
XT1 clock oscillation frequency (f <sub>XT</sub> ) <sup>Note</sup>	Crystal resonator		32	32.768	35	kHz

**Note** Indicates only permissible oscillator frequency ranges. Refer to AC Characteristics for instruction execution time. Request evaluation by the manufacturer of the oscillator circuit mounted on a board to check the oscillator characteristics.

**Caution** Since the CPU is started by the high-speed on-chip oscillator clock after a reset release, check the X1 clock oscillation stabilization time using the oscillation stabilization time counter status register (OSTC) by the user. Determine the oscillation stabilization time of the OSTC register and the oscillation stabilization time select register (OSTS) after sufficiently evaluating the oscillation stabilization time with the resonator to be used.

#### 3.2.2 On-chip oscillator characteristics

(T<sub>A</sub> = -40 to +105°C, 2.4 V ≤ V<sub>DD</sub> ≤ 5.5 V, V<sub>SS</sub> = 0 V)

Oscillators	Parameters	Conditions	MIN.	TYP.	MAX.	Unit
High-speed on-chip oscillator clock frequency <sup>Notes 1, 2</sup>	f <sub>HOCO</sub>		1		48	MHz
High-speed on-chip oscillator clock frequency accuracy		-20 to +85 °C	-1.0		+1.0	%
		-40 to -20 °C	-1.5		+1.5	%
		+85 to +105 °C	-2.0		+2.0	%
Low-speed on-chip oscillator clock frequency	f <sub>IL</sub>			15		kHz
Low-speed on-chip oscillator clock frequency accuracy			-15		+15	%

**Notes 1.** High-speed on-chip oscillator frequency is selected by bits 0 to 3 of option byte (000C2H/010C2H) and bits 0 to 2 of HOCODIV register.

**2.** This indicates the oscillator characteristics only. Refer to AC Characteristics for instruction execution time.

## 3.2.3 PLL oscillator characteristics

(T<sub>A</sub> = -40 to +105°C, 2.4 V ≤ V<sub>DD</sub> ≤ 5.5 V, V<sub>SS</sub> = 0 V)

Oscillators	Parameters	Conditions	MIN.	TYP.	MAX.	Unit
PLL input frequency <sup>Note</sup>	f <sub>PLLIN</sub>	High-speed system clock	6.00		16.00	MHz
PLL output frequency <sup>Note</sup>	f <sub>PLL</sub>			48.00		MHz
Lock up time		From PLL output enable to stabilization of the output frequency	40.00			μs
Interval time		From PLL stop to PLL re-operation setting Wait time	4.00			μs
Setting wait time		From after PLL input clock stabilization and PLL setting is fixed to start setting Wait time required	1.00			μs

**Note** Indicates only oscillator characteristics. Refer to AC Characteristics for instruction execution time.

### 3.3 DC Characteristics

#### 3.3.1 Pin characteristics

(T<sub>A</sub> = -40 to +105°C, 2.4 V ≤ V<sub>DD</sub> ≤ 5.5 V, V<sub>SS</sub> = 0 V)

Items	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Output current, high <sup>Note 1</sup>	I <sub>OH1</sub>	Per pin for P00, P01, P14 to P17, P30, P31, P40, P41, P50, P51, P70 to P75, P120, P130, P140	2.4 V ≤ V <sub>DD</sub> ≤ 5.5 V		-3.0 <sup>Note 2</sup>	mA
		Total of P00, P01, P40, P41, P120, P130, P140 (When duty ≤ 70% <sup>Note 3</sup> )	4.0 V ≤ V <sub>DD</sub> ≤ 5.5 V		-30.0	mA
			2.7 V ≤ V <sub>DD</sub> < 4.0 V		-10.0	mA
			2.4 V ≤ V <sub>DD</sub> < 2.7 V		-5.0	mA
		Total of P14 to P17, P30, P31, P50, P51, P70 to P75 (When duty ≤ 70% <sup>Note 3</sup> )	4.0 V ≤ V <sub>DD</sub> ≤ 5.5 V		-30.0	mA
			2.7 V ≤ V <sub>DD</sub> < 4.0 V		-19.0	mA
			2.4 V ≤ V <sub>DD</sub> < 2.7 V		-10.0	mA
		Total of all pins (When duty ≤ 70% <sup>Note 3</sup> )	2.4 V ≤ V <sub>DD</sub> ≤ 5.5 V		-60.0	mA
	I <sub>OH2</sub>	Per pin for P20 to P27	2.4 V ≤ V <sub>DD</sub> ≤ 5.5 V		-0.1 <sup>Note 2</sup>	mA
		Total of all pins (When duty ≤ 70% <sup>Note 3</sup> )	2.4 V ≤ V <sub>DD</sub> ≤ 5.5 V		-1.5	mA

- Notes**
1. Value of current at which the device operation is guaranteed even if the current flows from the V<sub>DD</sub> pin to an output pin.
  2. However, do not exceed the total current value.
  3. Specification under conditions where the duty factor ≤ 70%.

The output current value that has changed to the duty factor > 70% the duty ratio can be calculated with the following expression (when changing the duty ratio to n%).

- Total output current of pins = (I<sub>OH</sub> × 0.7)/(n × 0.01)

<Example> Where n = 80% and I<sub>OH</sub> = -10.0 mA

$$\text{Total output current of pins} = (-10.0 \times 0.7)/(80 \times 0.01) \cong -8.7 \text{ mA}$$

However, the current that is allowed to flow into one pin does not vary depending on the duty factor. A current higher than the absolute maximum rating must not flow into one pin.

**Caution** P00, P01, P30, and P74 do not output high level in N-ch open-drain mode.

**Remark** Unless specified otherwise, the characteristics of alternate-function pins are the same as those of the port pins.

(T<sub>A</sub> = -40 to +105°C, 2.4 V ≤ V<sub>DD</sub> ≤ 5.5 V, V<sub>SS</sub> = 0 V)

Items	Symbol	Conditions	MIN.	TYP.	MAX.	Unit		
Input leakage current, high	I <sub>LIH1</sub>	P00, P01, P14 to P17, P20 to P27, P30, P31, P40, P41, P50, P51, P60 to P63, P70 to P75, P120, P137, P140, RESET	V <sub>I</sub> = V <sub>DD</sub>		1	μA		
	I <sub>LIH2</sub>	P121 to P124 (X1, X2, XT1, XT2, EXCLK, EXCLKS)	V <sub>I</sub> = V <sub>DD</sub>	In input port or external clock input	1	μA		
				In resonator connection	10	μA		
Input leakage current, low	I <sub>LIL1</sub>	P00, P01, P14 to P17, P20 to P27, P30, P31, P40, P41, P50, P51, P60 to P63, P70 to P75, P120, P137, P140, RESET	V <sub>I</sub> = V <sub>SS</sub>		−1	μA		
	I <sub>LIL2</sub>	P121 to P124 (X1, X2, XT1, XT2, EXCLK, EXCLKS)	V <sub>I</sub> = V <sub>SS</sub>	In input port or external clock input	−1	μA		
				In resonator connection	−10	μA		
On-chip pll-up resistance	R <sub>U</sub>	P00, P01, P14 to P17, P30, P31, P40, P41, P50, P51, P70 to P75, P120, P140	V <sub>I</sub> = V <sub>SS</sub> , In input port		10	20	100	kΩ

**Remark** Unless specified otherwise, the characteristics of alternate-function pins are the same as those of the port pins.

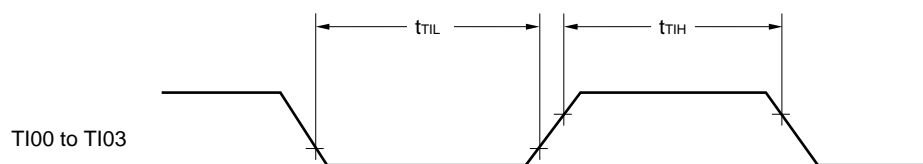
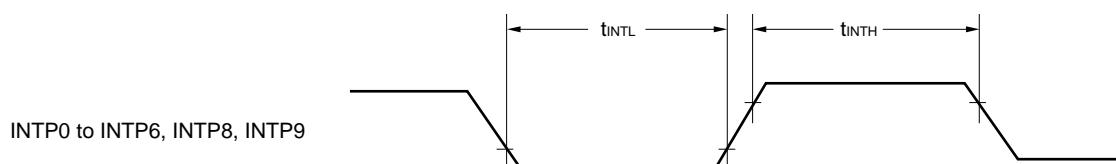
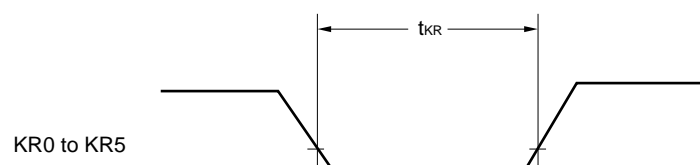
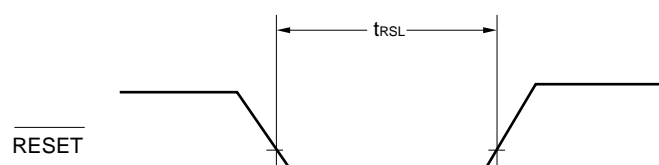
(T<sub>A</sub> = -40 to +105°C, 2.4 V ≤ V<sub>DD</sub> ≤ 5.5 V, V<sub>SS</sub> = 0 V)

(2/2)

Parameter	Symbol	Conditions				MIN.	TYP.	MAX.	Unit	
Supply current Note 1	I <sub>DD2</sub> Note 2	HALT mode	HS (High-speed main) mode Note 9	f <sub>HOCO</sub> = 48 MHz	V <sub>DD</sub> = 5.0 V		0.67	2.25	mA	
				f <sub>IH</sub> = 24 MHz <sup>Note 4</sup>	V <sub>DD</sub> = 3.0 V		0.67	2.25	mA	
				f <sub>HOCO</sub> = 24 MHz <sup>Note 7</sup>	V <sub>DD</sub> = 5.0 V		0.50	1.55	mA	
				f <sub>IH</sub> = 12 MHz <sup>Note 4</sup>	V <sub>DD</sub> = 3.0 V		0.50	1.55	mA	
				f <sub>HOCO</sub> = 12 MHz <sup>Note 7</sup>	V <sub>DD</sub> = 5.0 V		0.41	1.21	mA	
				f <sub>IH</sub> = 6 MHz <sup>Note 4</sup>	V <sub>DD</sub> = 3.0 V		0.41	1.21	mA	
				f <sub>HOCO</sub> = 6 MHz <sup>Note 7</sup>	V <sub>DD</sub> = 5.0 V		0.37	1.05	mA	
				f <sub>IH</sub> = 3 MHz <sup>Note 4</sup>	V <sub>DD</sub> = 3.0 V		0.37	1.05	mA	
				HS (High-speed main) mode Note 9	f <sub>MX</sub> = 20 MHz <sup>Note 3</sup> , V <sub>DD</sub> = 5.0 V	Square wave input		0.28	1.90	mA
						Resonator connection		0.45	2.00	mA
					f <sub>MX</sub> = 20 MHz <sup>Note 3</sup> , V <sub>DD</sub> = 3.0 V	Square wave input		0.28	1.90	mA
						Resonator connection		0.45	2.00	mA
					f <sub>MX</sub> = 10 MHz <sup>Note 3</sup> , V <sub>DD</sub> = 5.0 V	Square wave input		0.19	1.02	mA
						Resonator connection		0.26	1.10	mA
			f <sub>MX</sub> = 10 MHz <sup>Note 3</sup> , V <sub>DD</sub> = 3.0 V		Square wave input		0.19	1.02	mA	
					Resonator connection		0.26	1.10	mA	
			HS (High-speed main) mode (PLL operation) Note 9	f <sub>PLL</sub> = 48 MHz, f <sub>CLK</sub> = 24 MHz <sup>Note 3</sup>	V <sub>DD</sub> = 5.0 V		0.91	2.74	mA	
					V <sub>DD</sub> = 3.0 V		0.91	2.74	mA	
				f <sub>PLL</sub> = 48 MHz, f <sub>CLK</sub> = 12 MHz <sup>Note 3</sup>	V <sub>DD</sub> = 5.0 V		0.85	2.31	mA	
					V <sub>DD</sub> = 3.0 V		0.85	2.31	mA	
				f <sub>PLL</sub> = 48 MHz, f <sub>CLK</sub> = 6 MHz <sup>Note 3</sup>	V <sub>DD</sub> = 5.0 V		0.82	2.07	mA	
					V <sub>DD</sub> = 3.0 V		0.82	2.07	mA	
			Subsystem clock operation	f <sub>SUB</sub> = 32.768 kHz <sup>Note 5</sup> T <sub>A</sub> = −40°C	Square wave input		0.25	0.57	μA	
					Resonator connection		0.44	0.76	μA	
				f <sub>SUB</sub> = 32.768 kHz <sup>Note 5</sup> T <sub>A</sub> = +25°C	Square wave input		0.30	0.57	μA	
					Resonator connection		0.49	0.76	μA	
				f <sub>SUB</sub> = 32.768 kHz <sup>Note 5</sup> T <sub>A</sub> = +50°C	Square wave input		0.33	1.17	μA	
					Resonator connection		0.63	1.36	μA	
				f <sub>SUB</sub> = 32.768 kHz <sup>Note 5</sup> T <sub>A</sub> = +70°C	Square wave input		0.46	1.97	μA	
					Resonator connection		0.76	2.16	μA	
				f <sub>SUB</sub> = 32.768 kHz <sup>Note 5</sup> T <sub>A</sub> = +85°C	Square wave input		0.97	3.37	μA	
					Resonator connection		1.16	3.56	μA	
				f <sub>SUB</sub> = 32.768 kHz <sup>Note 5</sup> T <sub>A</sub> = +105°C	Square wave input		3.01	15.37	μA	
					Resonator connection		3.20	15.56	μA	
	I <sub>DD3</sub> <sup>Note 6</sup>	STOP mode Note 8	T <sub>A</sub> = −40°C					0.18	0.50	μA
			T <sub>A</sub> = +25°C					0.23	0.50	μA
			T <sub>A</sub> = +50°C					0.26	1.10	μA
			T <sub>A</sub> = +70°C					0.29	1.90	μA
			T <sub>A</sub> = +85°C					0.90	3.30	μA
			T <sub>A</sub> = +105°C					2.94	15.30	μA

(Notes and Remarks are listed on the next page.)



**TI/TO Timing****Interrupt Request Input Timing****Key Interrupt Input Timing** **$\overline{\text{RESET}}$  Input Timing**

**(5) Communication at different potential (2.5 V, 3 V) (UART mode) (2/2)****(T<sub>A</sub> = -40 to +105°C, 2.4 V ≤ V<sub>DD</sub> ≤ 5.5 V, V<sub>SS</sub> = 0 V)**

Parameter	Symbol	Conditions			MIN.	TYP.	MAX.	Unit
Transfer rate		transmission	4.0 V ≤ V <sub>DD</sub> ≤ 5.5 V,				<b>Note 1</b>	bps
			2.7 V ≤ V <sub>b</sub> ≤ 4.0 V	Theoretical value of the maximum transfer rate C <sub>b</sub> = 50 pF, R <sub>b</sub> = 1.4 kΩ, V <sub>b</sub> = 2.7 V			2.6 <sup>Note 2</sup>	Mbps
			2.7 V ≤ V <sub>DD</sub> < 4.0 V,				<b>Note 3</b>	bps
			2.3 V ≤ V <sub>b</sub> ≤ 2.7 V	Theoretical value of the maximum transfer rate C <sub>b</sub> = 50 pF, R <sub>b</sub> = 2.7 kΩ, V <sub>b</sub> = 2.3 V			1.2 <sup>Note 4</sup>	Mbps
			2.4 V ≤ V <sub>DD</sub> < 3.3 V,				<b>Notes 5, 6</b>	bps
			1.6 V ≤ V <sub>b</sub> ≤ 2.0 V	Theoretical value of the maximum transfer rate C <sub>b</sub> = 50 pF, R <sub>b</sub> = 5.5 kΩ, V <sub>b</sub> = 1.6 V			0.43 <sup>Note 7</sup>	Mbps

**Notes 1.** The smaller maximum transfer rate derived by using f<sub>MCK</sub>/12 or the following expression is the valid maximum transfer rate.

Expression for calculating the transfer rate when 4.0 V ≤ V<sub>DD</sub> ≤ 5.5 V and 2.7 V ≤ V<sub>b</sub> ≤ 4.0 V

$$\text{Maximum transfer rate} = \frac{1}{\{-C_b \times R_b \times \ln(1 - \frac{2.2}{V_b})\} \times 3} \text{ [bps]}$$

$$\text{Baud rate error (theoretical value)} = \frac{\frac{1}{\text{Transfer rate} \times 2} - \{-C_b \times R_b \times \ln(1 - \frac{2.2}{V_b})\}}{(\frac{1}{\text{Transfer rate}}) \times \text{Number of transferred bits}} \times 100 \text{ [%]}$$

\* This value is the theoretical value of the relative difference between the transmission and reception sides.

2. This value as an example is calculated when the conditions described in the “Conditions” column are met. Refer to Note 1 above to calculate the maximum transfer rate under conditions of the customer.

3. The smaller maximum transfer rate derived by using f<sub>MCK</sub>/12 or the following expression is the valid maximum transfer rate.

Expression for calculating the transfer rate when 2.7 V ≤ V<sub>DD</sub> < 4.0 V and 2.3 V ≤ V<sub>b</sub> ≤ 2.7 V

$$\text{Maximum transfer rate} = \frac{1}{\{-C_b \times R_b \times \ln(1 - \frac{2.0}{V_b})\} \times 3} \text{ [bps]}$$

$$\text{Baud rate error (theoretical value)} = \frac{\frac{1}{\text{Transfer rate} \times 2} - \{-C_b \times R_b \times \ln(1 - \frac{2.0}{V_b})\}}{(\frac{1}{\text{Transfer rate}}) \times \text{Number of transferred bits}} \times 100 \text{ [%]}$$

\* This value is the theoretical value of the relative difference between the transmission and reception sides.

4. This value as an example is calculated when the conditions described in the “Conditions” column are met. Refer to Note 3 above to calculate the maximum transfer rate under conditions of the customer.

5. Use it with V<sub>DD</sub> ≥ V<sub>b</sub>.

**(6) Communication at different potential (1.8 V, 2.5 V, 3 V) (CSI mode) (master mode, SCKp... internal clock output) (1/2)****(T<sub>A</sub> = -40 to +105°C, 2.4 V ≤ V<sub>DD</sub> ≤ 5.5 V, V<sub>SS</sub> = 0 V)**

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
SCKp cycle time	t <sub>KCY1</sub>	t <sub>KCY1</sub> ≥ 4/f <sub>CLK</sub> 4.0 V ≤ V <sub>DD</sub> ≤ 5.5 V, 2.7 V ≤ V <sub>b</sub> ≤ 4.0 V, C <sub>b</sub> = 30 pF, R <sub>b</sub> = 1.4 kΩ	600			ns
		2.7 V ≤ V <sub>DD</sub> < 4.0 V, 2.3 V ≤ V <sub>b</sub> ≤ 2.7 V, C <sub>b</sub> = 30 pF, R <sub>b</sub> = 2.7 kΩ	1000			ns
		2.4 V ≤ V <sub>DD</sub> < 3.3 V, 2.4 V ≤ V <sub>b</sub> ≤ 2.0 V, C <sub>b</sub> = 30 pF, R <sub>b</sub> = 5.5 kΩ	2300			ns
SCKp high-level width	t <sub>KH1</sub>	4.0 V ≤ V <sub>DD</sub> ≤ 5.5 V, 2.7 V ≤ V <sub>b</sub> ≤ 4.0 V, C <sub>b</sub> = 30 pF, R <sub>b</sub> = 1.4 kΩ	t <sub>KCY1</sub> /2 – 150			ns
		2.7 V ≤ V <sub>DD</sub> < 4.0 V, 2.3 V ≤ V <sub>b</sub> ≤ 2.7 V, C <sub>b</sub> = 30 pF, R <sub>b</sub> = 2.7 kΩ	t <sub>KCY1</sub> /2 – 340			ns
		2.4 V ≤ V <sub>DD</sub> < 3.3 V, 1.6 V ≤ V <sub>b</sub> ≤ 2.0 V, C <sub>b</sub> = 30 pF, R <sub>b</sub> = 5.5 kΩ	t <sub>KCY1</sub> /2 – 916			ns
SCKp low-level width	t <sub>KL1</sub>	4.0 V ≤ V <sub>DD</sub> ≤ 5.5 V, 2.7 V ≤ V <sub>b</sub> ≤ 4.0 V, C <sub>b</sub> = 30 pF, R <sub>b</sub> = 1.4 kΩ	t <sub>KCY1</sub> /2 – 24			ns
		2.7 V ≤ V <sub>DD</sub> < 4.0 V, 2.3 V ≤ V <sub>b</sub> ≤ 2.7 V, C <sub>b</sub> = 30 pF, R <sub>b</sub> = 2.7 kΩ	t <sub>KCY1</sub> /2 – 36			ns
		2.4 V ≤ V <sub>DD</sub> < 3.3 V, 1.6 V ≤ V <sub>b</sub> ≤ 2.0 V, C <sub>b</sub> = 30 pF, R <sub>b</sub> = 5.5 kΩ	t <sub>KCY1</sub> /2 – 100			ns

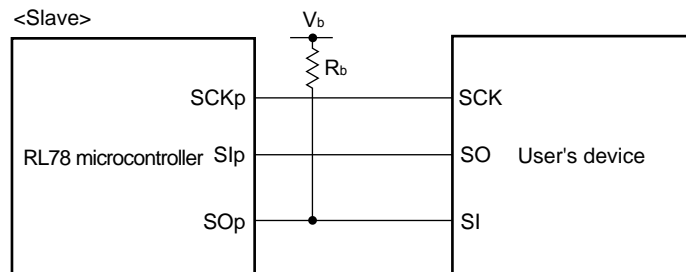
**Cautions** 1. Select the TTL input buffer for the SIp pin and the N-ch open drain output (V<sub>DD</sub> tolerance) mode for the SOp pin and SCKp pin by using port input mode register g (PIMg) and port output mode register g (POMg). For V<sub>IH</sub> and V<sub>IL</sub>, see the DC characteristics with TTL input buffer selected.

2. Use it with V<sub>DD</sub> ≥ V<sub>b</sub>.

(Remarks are listed two pages after the next page.)

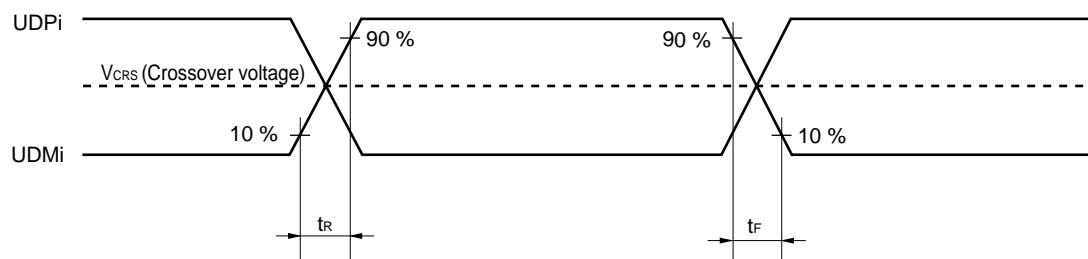
**Caution** Select the TTL input buffer for the SIp pin and SCKp pin and the N-ch open drain output ( $V_{DD}$  tolerance) mode for the SOp pin by using port input mode register g (PIMg) and port output mode register g (POMg). For  $V_{IH}$  and  $V_{IL}$ , see the DC characteristics with TTL input buffer selected.

**CSI mode connection diagram (during communication at different potential)**



- Remarks**
1.  $R_b[\Omega]$ : Communication line (SO<sub>p</sub>) pull-up resistance,  $C_b[F]$ : Communication line (SO<sub>p</sub>) load capacitance,  $V_b[V]$ : Communication line voltage
  2. p: CSI number (p = 00), m: Unit number, n: Channel number (mn = 00), g: PIM and POM number (g = 0, 3, 5, 7)
  3.  $f_{MCK}$ : Serial array unit operation clock frequency  
(Operation clock to be set by the CKSmn bit of serial mode register mn (SMRmn).  
m: Unit number, n: Channel number (mn = 00))
  4. CSI01 cannot communicate at different potential. Use other CSI for communication at different potential.

## Timing of UDPI and UDMi



## (2) BC standard

(T<sub>A</sub> =  $-40$  to  $+105^\circ\text{C}$ ,  $3.0\text{ V} \leq UV_{DD} \leq 3.6\text{ V}$ ,  $3.0\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ ,  $V_{SS} = 0\text{ V}$ )

	Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
USB standard BC1.2	UDPi sink current	I <sub>DP_SINK</sub>		25		175	$\mu\text{A}$
	UDMi sink current	I <sub>DM_SINK</sub>		25		175	$\mu\text{A}$
	DCD source current	I <sub>DP_SRC</sub>		7		13	$\mu\text{A}$
	Dedicated charging port resistor	R <sub>DCP_DAT</sub>	$0\text{ V} < \text{UDP/UDM voltage} < 1.0\text{ V}$			200	$\Omega$
	Data detection voltage	V <sub>DAT_REF</sub>		0.25		0.4	V
	UDPi source voltage	V <sub>DP_SRC</sub>	Output current $250\text{ }\mu\text{A}$	0.5		0.7	V
	UDMi source voltage	V <sub>DM_SRC</sub>	Output current $250\text{ }\mu\text{A}$	0.5		0.7	V

Remark i = 0, 1